



PRODUCT SPECIFICATION
MONO LCD MODULE
MODEL: G1206E0SGW1G-A0 Ver:1.0

< ◇ > Preliminary Specification

< ◆ > Finally Specification

CUSTOMER'S APPROVAL	
CUSTOMER :	
SIGNATURE:	DATE:

APPROVED BY	PM REVIEWED	PD REVIEWED	PREPARED BY

Revision Status

Version	Revise Date	Page	Content	Modified By
Ver. 1.0	2011.01.28		First Issued	

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1. Features

The features of LCD are as follows

- * Display mode : STN/Blue/Transimissive/ Negative
- * Driver/Controller IC : ST7565R
- * Interface Input Data : 8080 series
- * Driving Method : 1/65 Duty, 1/9 Bias
- * Viewing Direction : 6 O'clock
- * Backlight : LED(White)
- * Sample NO : G1206E0SGW1G-A0_01/20110127

2. MECHANICAL SPECIFICATIONS

Item	Specification	Unit
Module Size	69.2(W) x 44.6(H) x 6(D)	mm
Viewing Area	50MIN(W) x 33MIN(H)	mm
Active Area	46.05MIN(W) x 30.57MIN(H)	mm
Number of Dots	128 X64 Dots+Icons	-
Dot Size	0.33(W) x 0.37(H)	mm
Dot Pitch	0.36(W) x 0.4(H)	mm

3. ELECTRICAL SPECIFICATIONS

3-1 ABSOLUTR MAZIMUM RATINGS (Ta = 25 °C)

Item	Symbol	Standard Value			Unit
		Min.	Typ.	Max.	
Supply Voltage For Logic	$V_{DD} - V_{SS}$	-0.3	-	3.6	V
Supply Voltage For LCD Drive	V_{LCD}	3.0	-	12	V
Input Voltage	V_{in}	-0.3	-	$V_{DD}+0.3$	V
Operating Temp.	Top	-10	-	+60	°C
Storage Temp.	Tst	-20	-	+70	°C

*. NOTE: The response time will be extremely slow when the operating temperature is around -20°C, and the back ground will become darker at high temperature operating.

3-2 ELECTRICAL CHARACTERISTICS

Item	Symbol	Test Condition	Min.	Typ.	Max.	Unit	
Logic supply Voltage	V _{DD} - V _{SS}	V _{DD} =3.3V ± 10%	3.0	3.3	3.6	V	
LCD Drive	V _{LCD}		9.2	9.5	9.8	V	
Input Voltage	"H" Level		V _{IH}	0.8 V _{DD}	-	V _{DD}	V
	"L" Level		V _{IL}	V _{SS}	-	0.2V _{DD}	V
Frame Frequency	f _{FLM}			70		Hz	
Current Consumption	I _{DD}			-	0.61	-	mA

3-3. BACKLIGHT

3-3-1. Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Current	I _F	T _a = 25 °C	-	-	45	mA
Reverse Voltage	V _R		-	-	5	V
Power Dissipation	P _D		-	-	192	mW

3-3-2. Electrical-optical Characteristics

Item	Symbol	Condition	Min.		Typ.		Max.		Unit
Forward Voltage	V _F	I _f =45mA T _a = 25 °C	2.8		3.1		3.2		V
Luminous intensity	I _v		-		250		-		cd/m ²
Colour coordinate	-		x	Y	Y	Y	x	Y	-
			0.25	0.25	0.28	0.28	0.31	0.31	

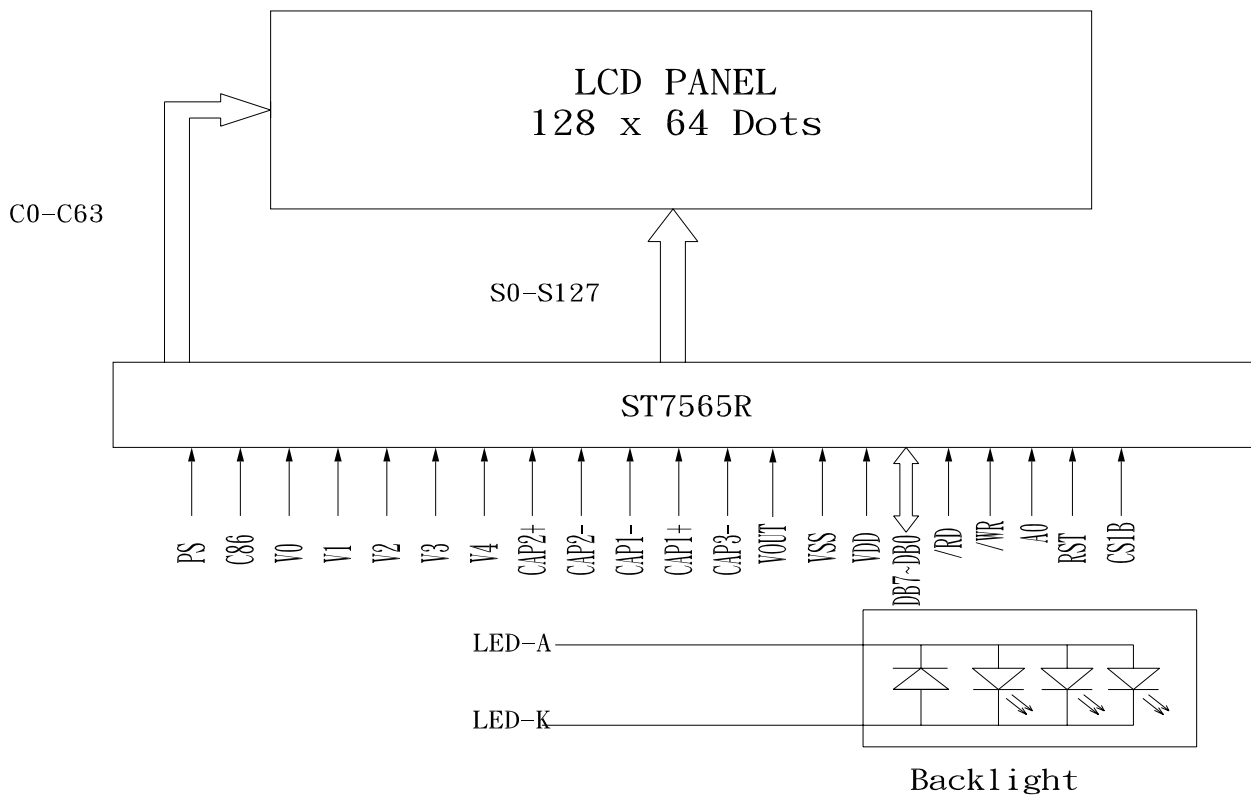
The brightness is measured without LCD panel

4. TERMINAL FUNCTIONS AND BLOCK DIAGRAM

4-1. INTERFACE PIN FUNCTION DESCRIPTION

PIN NO.	SYMBOL	FUNCTIONS
1	PS	Serial data input
2	C86	8080 series MPU interface
3-7	V0-V4	LCD driver supplies voltages
8	CAP2N	DC/DC voltage converter
9	CAP2P	DC/DC voltage converter
10	CAP1P	DC/DC voltage converter
11	CAP1N	DC/DC voltage converter
12	CAP3P	DC/DC voltage converter
13	VOUT	DC/DC voltage converter output
14	VSS	Ground
15	VDD	Supply voltage for logical circuit
16-23	DB7~DB0	Data bus line
24	/RD	Read signal or Enable signal
25	/WR	Write signal or Select read or write signal
26	A0	This is connected to the least significant bit of the normal MPU address bus, and it determines whether the data bits are data or a command.
27	RST	Register signal
28	CS1B	Chip Selection Signal
29	LED-A	Backlight (+)
30	LED-K	Backlight -

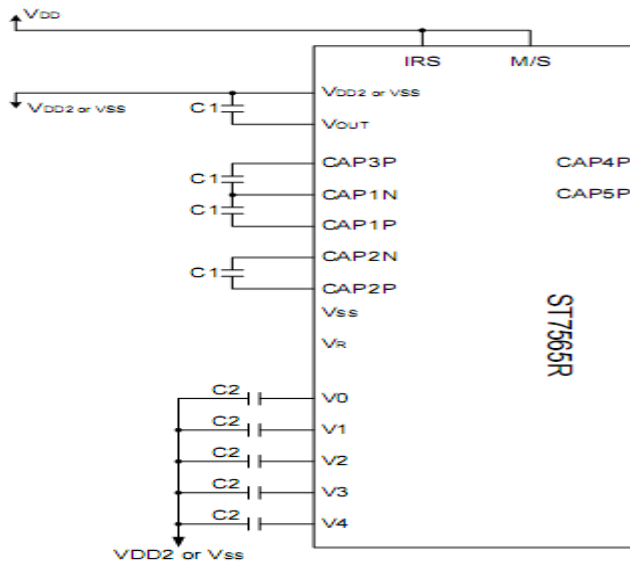
4-2. BLOCK DIAGRAM



4-3 POWER SUPPLY

(1) When the voltage regulator internal resistor is used.

(Example where $V_{DD2} = V_{DD}$, with 4x step-up)



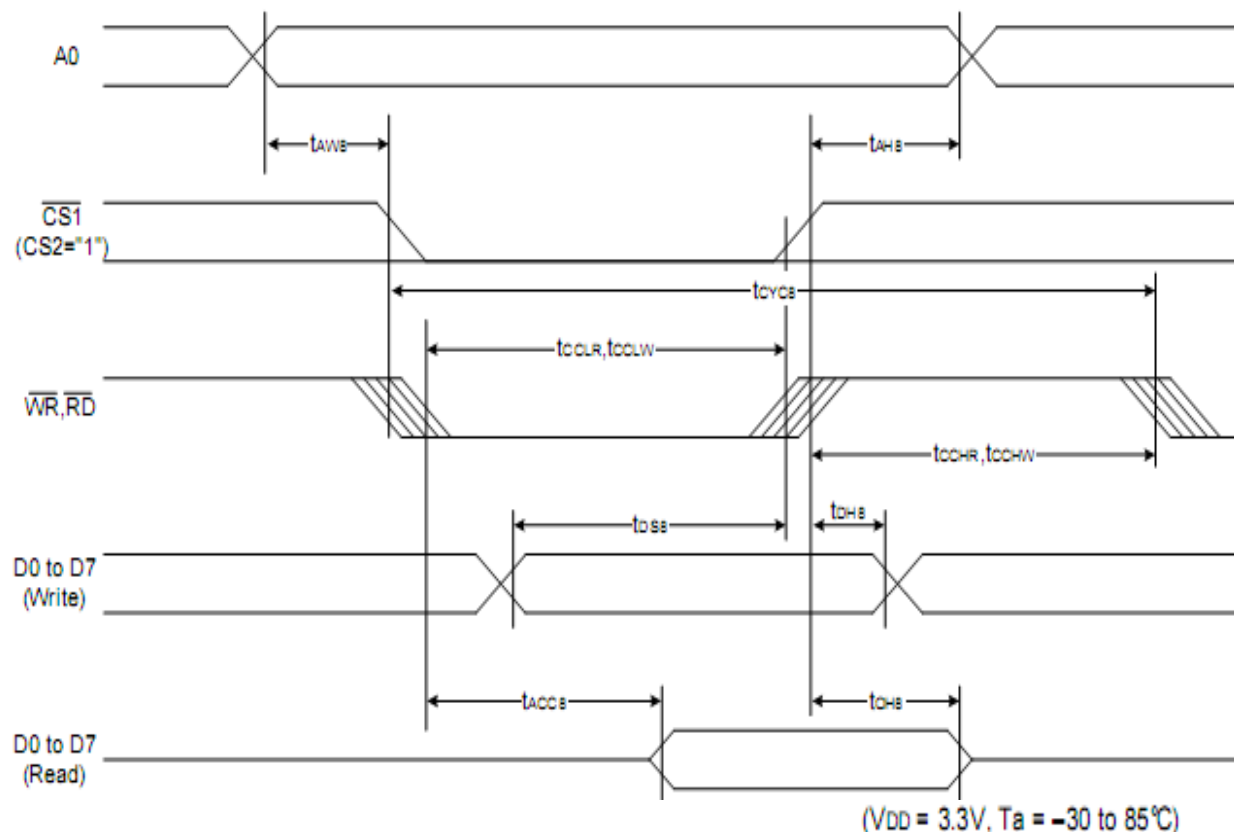
Item	Set value	unit
C1	1 ~ 2.2	uF
C2	0.1 ~ 1	uF

Note:

- C1 ~ C2 are determined by the size of the LCD being driven.
- The recommended panel size is smaller than 1.8".
- If the panel loading is too heavy and cause poor display quality, adding V0 capacitor can improve display quality.

5. TIMING CHARACTERISTICS

System Bus Read/Write Characteristics 1 (For the 8080 Series MPU)



Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Address hold time	A0	tAHS		0	—	Ns
Address setup time		tAWS		0	—	
System cycle time		tCYCS		240	—	
Enable L pulse width (WRITE)	WR	tOCLW		80	—	
Enable H pulse width (WRITE)		tOCHW		80	—	
Enable L pulse width (READ)	RD	tOCLR		140	—	
Enable H pulse width (READ)		tOCHR		80	—	
WRITE Data setup time	D0 to D7	tDSS		40	—	
WRITE Address hold time		tDHS		0	—	
READ access time		tACCs	CL = 100 pF	—	70	
READ Output disable time		tOHS	CL = 100 pF	5	50	

*1 The input signal rise time and fall time (t_r , t_f) is specified at 15 ns or less. When the system cycle time is extremely fast, $(t_r + t_f) \leq (t_{CYCS} - t_{OCLW} - t_{OCHW})$ for $(t_r + t_f) \leq (t_{CYCS} - t_{OCLR} - t_{OCHR})$ are specified.

*2 All timing is specified using 20% and 80% of VDD as the reference.

*3 tOCLW and tOCLR are specified as the overlap between /CS1 being "L" (CS2 = "H") and /WR and /RD being at the "L" level.

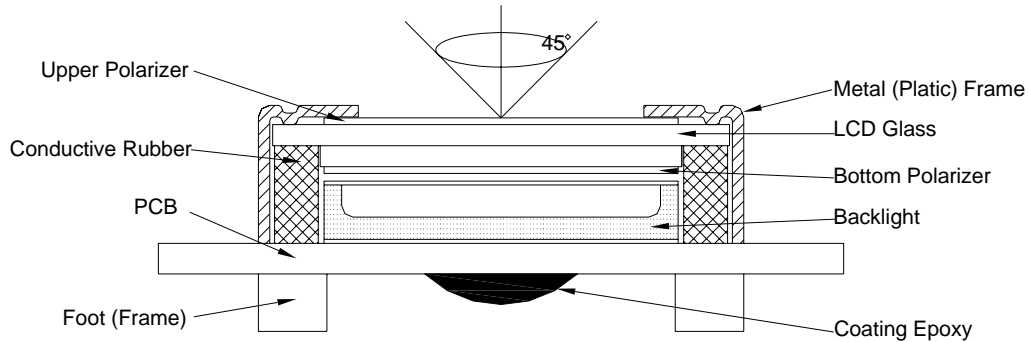
6. INSTRUCTION SET

Command	Command Code										Function	
	A0	/RD	/WR	D7	D6	D5	D4	D3	D2	D1		D0
(1) Display ON/OFF	0	1	0	1	0	1	0	1	1	1	0	LCD display ON/OFF 0: OFF, 1: ON
(2) Display start line set	0	1	0	0	1	Display start address						Sets the display RAM display start line address
(3) Page address set	0	1	0	1	0	1	1	Page address				Sets the display RAM page address
(4) Column address set upper bit	0	1	0	0	0	0	1	Most significant column address				Sets the most significant 4 bits of the display RAM column address.
Column address set lower bit	0	1	0	0	0	0	0	Least significant column address				Sets the least significant 4 bits of the display RAM column address.
(5) Status read	0	0	1	Status				0	0	0	0	Reads the status data
(6) Display data write	1	1	0	Write data								Writes to the display RAM
(7) Display data read	1	0	1	Read data								Reads from the display RAM
(8) ADC select	0	1	0	1	0	1	0	0	0	0	0	Sets the display RAM address SEG output correspondence 0: normal, 1: reverse
(9) Display normal/reverse	0	1	0	1	0	1	0	0	1	1	0	Sets the LCD display normal/reverse 0: normal, 1: reverse
(10) Display all points ON/OFF	0	1	0	1	0	1	0	0	1	0	0	Display all points 0: normal display 1: all points ON
(11) LCD bias set	0	1	0	1	0	1	0	0	0	1	0	Sets the LCD drive voltage bias ratio 0: 1/9 bias, 1: 1/7 bias (ST7565R)
(12) Read/modify/write	0	1	0	1	1	1	0	0	0	0	0	Column address increment At write: +1 At read: 0
(13) End	0	1	0	1	1	1	0	1	1	1	0	Clear read/modify/write
(14) Reset	0	1	0	1	1	1	0	0	0	1	0	Internal reset
(15) Common output mode select	0	1	0	1	1	0	0	0	*	*	*	Select COM output scan direction 0: normal direction 1: reverse direction
(16) Power control set	0	1	0	0	0	1	0	1	Operating mode			Select internal power supply operating mode
(17) Vo voltage regulator internal resistor ratio set	0	1	0	0	0	1	0	0	Resistor ratio			Select internal resistor ratio(Rb/Ra) mode
(18) Electronic volume mode set Electronic volume register set	0	1	0	1	0	0	0	0	0	0	1	Set the Vo output voltage electronic volume register
(19) Static indicator ON/OFF Static indicator register set	0	1	0	1	0	1	0	1	1	0	0	0: OFF, 1: ON Set the flashing mode
(20) Booster ratio set	0	1	0	1	1	1	1	1	0	0	0	select booster ratio 00: 2x,3x,4x 01: 5x 11: 6x
(21) Power saver												Display OFF and display all points ON compound command
(22) NOP	0	1	0	1	1	1	0	0	0	1	1	Command for non-operation
(23) Test	0	1	0	1	1	1	1	*	*	*	*	Command for IC test. Do not use this command

7. QUALITY SPECIFICATIONS

7 - 1. LCM Appearance and Electric inspection Condition

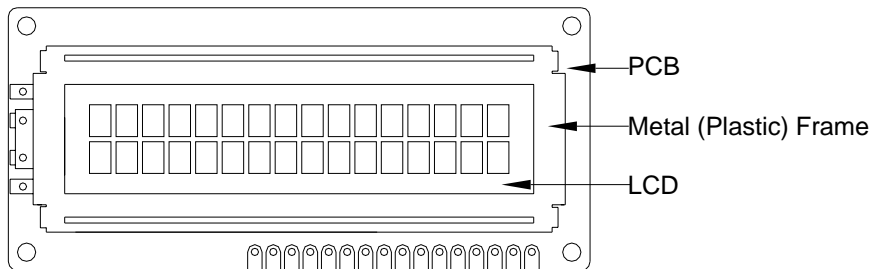
1. Inspection will be done by placing LCM 30cm away from inspector's eyeballs under normal illumination.



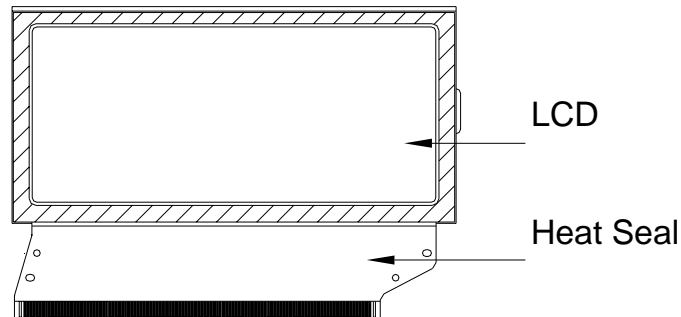
2. View Angle: with in 45° around perpendicular line.

7 - 2. Definition

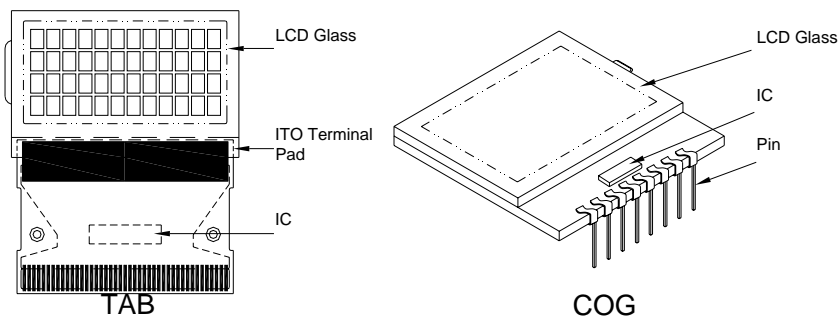
1. COB



2. Heat Seal



3. TAB and COG



7-3. Sampling Plan and Acceptance

1. Sampling Plan

MIL - STD - 105E (||) ordinary single inspection is used.

2. Acceptance

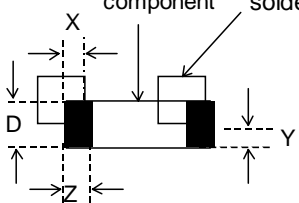
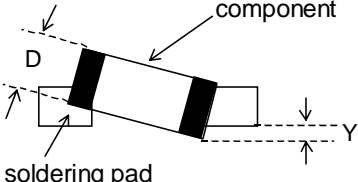
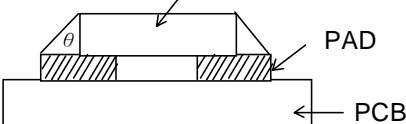
Major defect: AQL = 0.65%

Minor defect: AQL = 1.5%

7-4. Criteria**1. COB**

Defect	Inspection Item	Inspection Standards	
Major	PCB copper flakes peeling off	Any copper flake in viewing Area should be greater than 1.0mm ²	Reject
Major	Height of coating epoxy	Exceed the dimension of drawing	Reject
Major	Void or hole of coating epoxy	Expose bonding wire or IC	Reject
Major	PCB cutting defect	Exceed the dimension of drawing	Reject

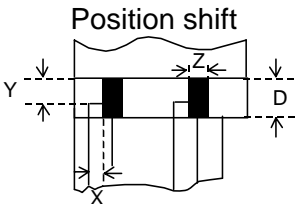
2. SMT

Defect	Inspection Item	Inspection Standards	
Minor	Component marking not readable		Reject
Minor	Component height	Exceed the dimension Of drawing	Reject
Major	Component solder defect (missing , extra, wrong component or wrong orientation)		Reject
Minor	Component position shift 	$X < 3/4Z$ $Y > 1/3D$	Reject Reject
Minor	Component tilt 	$Y > 1/3D$	Reject
Minor	Insufficient solder 	$\theta \leq 20^\circ$	Reject

3. Metal (Plastic) Frame

Defect	Inspection Item	Inspection Standards		
Major	Crack / breakage	Anywhere		
			Reject	
Minor	Frame Scratch	W	L	Acceptable of Scratch
		$w < 0.1\text{mm}$	Any	Ignore
		$0.1 \leq w < 0.2\text{mm}$	$L \leq 5.0\text{mm}$	2
		$0.2 \leq w < 0.3\text{mm}$	$L \leq 3.0\text{mm}$	1
		$w \geq 0.3\text{mm}$	Any	0
		Note : 1. Above criteria applicable to scratch lines with distance greater than 5mm. 2. Scratch on the back side of frame (not visible) can be ignored .		
Minor	Frame Dent , Prick $\Phi = \frac{L + W}{2}$		Acceptable of Dents / Pricks	
		$\Phi \leq 1.0\text{mm}$	2	
		$1.0 < \Phi \leq 1.5\text{mm}$	1	
		$1.5\text{mm} < \Phi$	0	
Note : 1. Above criteria applicable to any two dents / pricks with distance greater than 5mm 2. Dent / prick on the back side of frame (not visible) can be ignored				
Minor	Frame Deformation	Exceed the dimension of drawing		
Minor	Metal Frame Oxidation	Any rust		

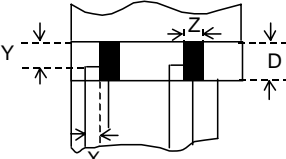
4. Flexible Film Connector (FFC)

Defect	Inspection Item	Inspection Standards	
Minor	Tilted soldering	Within the angle $+5^\circ$	Acceptable
Minor	Uneven solder joint /bump		Reject
Minor	Hole $\Phi = \frac{L + W}{2}$	Expose the conductive line	Reject
		$\Phi > 1.0\text{mm}$	Reject
Minor		$Y > 1/3D$	Reject
		$X > 1/2Z$	Reject

5. Screw

Defect	Inspection Item	Inspection Standards	
Major	Screw missing/loosen		Reject
Minor	Screw oxidation	Any rust	Reject
Minor	Screw deformation	Difficult to accept screw driver	Reject

6. Heatseal 、TCP 、FPC

Defect	Inspection Item	Inspection Standards	
Major	Scratch expose conductive layer		Reject
Minor	HS Hole $\Phi = \frac{L+W}{2}$	$\Phi > 0.5\text{mm}$	Reject
Major	Adhesion strength	Less than the specification	Reject
Minor	Position shift 	$Y > 1/3D$	Reject
		$X > 1/2Z$	Reject
Major	Conductive line break		Reject

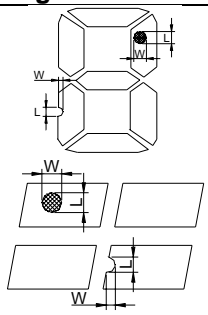
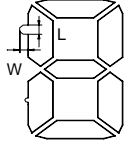
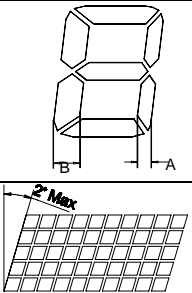
7. LED Backing Protective Film and Others

Defect	Inspection Item	Inspection Standards	
Minor	LED dirty, prick	Acceptable number of units	
		$\Phi \leq 0.10\text{mm}$	Ignore
		$0.10 < \Phi \leq 0.15\text{mm}$	2
		$0.15 < \Phi \leq 0.2\text{mm}$	1
		$\Phi > 0.2\text{mm}$	0
The distance between any two spots should be $\geq 5\text{mm}$ Any spot/dot/void outside of viewing area is acceptable			
Minor	Protective film tilt	Not fully cover LCD	Reject
Major	COG coating	Not fully cover ITO circuit	Reject

8. Electric Inspection

Defect	Inspection Item	Inspection Standards	
Major	Short		Reject
Major	Open		Reject

9. Inspection Specification of LCD

Defect	Inspect Item	Inspection Standards				
		W	$W \leq 0.03$	$0.03 < W \leq 0.05$	$W > 0.05$	
Minor	Linear Defect * Glass Scratch * Polarizer Scratch * Fiber and Linear material	L	$L < 5$	$L < 3$	Any	
		ACC. NO.	1	1	Reject	
		Note	L is the length and W is the width of the defect			
Minor	Black Spot and Polarizer Pricked * Foreign material between glass and polarizer or glass and glass * Polarizer hole or protuberance by external force	Φ	$\Phi \leq 0.1$	$0.1 < \Phi \leq 0.15$	$0.15 < \Phi \leq 0.2$	$\Phi > 0.2$
		ACC. NO.	3EA / 100mm ²	2	1	0
		Note	Φ is the average diameter of the defect. Distance between two defects > 10mm.			
Minor	White Spot and Bubble in polarizer * Unobvious transparent foreign material between glass and glass or glass and polarizer * Air protuberance between polarizer and glass	Φ	$\Phi \leq 0.3$	$0.3 < \Phi \leq 0.5$	$0.5 < \Phi$	
		ACC. NO.	3EA / 100mm ²	1	0	
		Note	Φ is the average diameter of the defect. Distance between two defects > 10mm.			
Minor	Segment Defect 	Φ	$\Phi \leq 0.10$	$0.10 < \Phi \leq 0.20$	$0.20 < \Phi \leq 0.25$	$\Phi > 0.25$
		ACC. NO.	3EA / 100mm ²	2	1	0
		Note	W is more than 1/2 segment width			Reject
			$\Phi = \frac{L + W}{2}$ Distance between two defect is 10mm			
Minor	Protuberant Segment  $\Phi = (L + W) / 2$	Φ	$\Phi \leq 0.10$	$0.10 < \Phi \leq 0.20$	$0.20 < \Phi \leq 0.25$	$\Phi > 0.25$
		W	Glue	$W \leq 1/2$ Seg $W < 0.2$	$W \leq 1/2$ Seg $W < 0.2$	Ignore
		ACC. NO.	3EA / 100mm ²	2	1	0
Minor	Assembly Mis-alignment 	1. Segment				
		B	$B \leq 0.4\text{mm}$	$0.4 < B \leq 1.0\text{mm}$	$B > 1.0\text{mm}$	
		B-A	$B-A < 1/2B$	$B-A < 0.2$	$B-A < 0.25$	
		Judge	Acceptable	Acceptable	Acceptable	
		2. Dot Matrix				
		Deformation > 2°				Reject
Minor	Stain on LCD Panel Surface	Accept when stains can be wiped lightly with a soft cloth or a similar one. Otherwise, judged according to the above items: "Black spot" and "White Spot"				

8. RELIABILITY

NO.	Item	Condition	Criterion
1	High Temperature Operating	60°C , 96Hrs	No defect in cosmetic and operational function allowable.
2	Low Temperature Operating	-10°C , 96Hrs	
3	High Humidity	50°C , 90%RH, 96Hrs	
4	High Temperature Storage	70°C , 96Hrs	
5	Low Temperature Storage	-20°C , 96Hrs	
6	Vibration	Random wave 10 ~ 100Hz Acceleration: 2g 2 Hrs per direction(X,Y,Z)	Total current Consumption should be below double of initial value.
7	Thermal Shock	-10°C to 25°C to 60°C (60Min) (5Min) (60Min) 16Cycles	
8	ESD Testing	Contract Discharge Voltage: +1 ~ 5kV and -1 ~ -5kV	There will be discharged ten times at every discharging voltage cycle. The voltage gap is 1kV.
		Air Discharge Voltage: +1 ~ 8kV and -1 ~ -8kV	

Note: 1) Above conditions are suitable for our company standard products.

2) For restrict products, the test conditions listed as above must be revised.

9. HANDLING PRECAUTION

(1) Mounting Method

The panel of the LCD Module consists of two thin glass plates with polarizers which easily get damaged since the Module is fixed by utilizing fitting holes in the printed circuit board. Extreme care should be taken when handling the LCD Modules.

(2) Caution of LCD handling & cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and wipe lightly.

- Isopropyl alcohol
- Ethyl alcohol
- Trichloro trifluro thane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Ketone
- Aromatics

(3) Caution against static charge

The LCD Module use C-MOS LSI drivers, so we recommend that you connect any unused input terminal to VDD or VSS, do not input any signals before power is turned on. And ground your body, Work/assembly table. And assembly equipment to protect against static electricity.

(4) Packaging

- Modules use LCD elements, and must be treated as such. Avoid intense shock and falls from a height.
- To prevent modules from degradation. Do not operate or store them exposed directly to sunshine or high temperature/humidity.

(5) Caution for operation

- It is indispensable to drive LCD's within the specified voltage limit since the higher voltage than the limit shorten LCD life. An electrochemical reaction due to direct current causes LCD deterioration, Avoid the use of direct current drive.
- Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's. Which will come back in the specified operating temperature range.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the relative condition of 40°C, 50%RH or less is reequired.

(6) Storage

In the case of storing for a long period of time (for instance.) For years) for the purpose or replacement use, The following ways are recommended.

- Storage in a polyethylene bag with sealed so as not to enter fresh air outside in it, And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light is. Keeping temperature in the specified storage temperature range.
- Storing with no touch on polarizer surface by the anything else. (It is recommended to store them as they have been contained in the inner container at the time of delivery)

(7) Safety

- It is recommendable to crash damaged or unnecessary LCD into pieces and wash off liquid crystal by using solvents such as acetone and ethanol.

Which should be burned up later.

10. OUTLINE DIMENSION

